High Power PoE Signal Path Magnetics

- Meets the current requirements of Gigabit PoE Plus.
- Open circuit inductance is ≥350 µH with a 22.5 mA dc offset

Core material: Ferrite
Terminations: RoHS Tin-silver-copper over tin over nickel over phosphor bronze. Other terminations available at additional cost.

Weight: HPF2187L: 240 mg; HPX2126L: 3.9 g

Ambient temperature: -40°C to +85°C

Storage temperature: Component: -40°C to +85°C.
Tape and reel packaging: -40°C to +80°C

Resistance to soldering heat: Max three 40 second reflows at +260°C, parts cooled to room temperature between cycles

Moisture Sensitivity Level (MSL): 1 (unlimited floor life at <30°C / 85% relative humidity)

Packaging:
HPF2187L: 500/7” reel; 2000/13” reel; Plastic tape: 16 mm wide, 0.35 mm thick, 8 mm pocket spacing, 4.4 mm pocket depth
HPX2126L: 300/13” reel; Plastic tape: 32 mm wide, 0.5 mm thick, 20 mm pocket spacing, 11 mm pocket depth


Isolation Transformer

<table>
<thead>
<tr>
<th>Part number1</th>
<th>Inductance2 (µH)</th>
<th>DCR max3 (Ohms)</th>
<th>Isolation4 (Vrms)</th>
<th>Irms5 (A)</th>
</tr>
</thead>
<tbody>
<tr>
<td>HPX2126L_</td>
<td>850</td>
<td>0.24</td>
<td>1500</td>
<td>1.9</td>
</tr>
</tbody>
</table>

1. When ordering, please specify packaging code:

   HPX2126L D

   Packaging: D = 13” machine-ready reel. EIA-481 embossed plastic tape (300 parts per full reel). Quantities less than full reel available: in tape (not machine ready) or with leader and trailer ($25 charge).

   B = Less than full reel. In an effort to simplify our part numbering system, Coilcraft is eliminating the need for multiple packaging codes. When ordering, simply change the last letter of your part number from B to D.

2. Inductance measured at 100 kHz, 0.1 Vrms, 0 Adc.
3. DCR is for each winding.
4. Isolation is measured from primary to secondary of each transformer.
5. Current flowing through each secondary that causes a 20°C temperature rise from 25°C ambient
6. Electrical specifications at 25°C.

Refer to Doc 362 “Soldering Surface Mount Components” before soldering.

Common Mode Choke

<table>
<thead>
<tr>
<th>Part number1</th>
<th>Inductance2 (µH)</th>
<th>DCR max3 (Ohms)</th>
</tr>
</thead>
<tbody>
<tr>
<td>HPF2187L_</td>
<td>10.0</td>
<td>0.15</td>
</tr>
</tbody>
</table>

1. When ordering, please specify packaging code:

   HPF2187L C

   Packaging: C = 7” machine-ready reel. EIA-481 embossed plastic tape (500 parts per full reel). Quantities less than full reel available: in tape (not machine ready) or with leader and trailer ($25 charge).

   D = 13” machine-ready reel. EIA-481 embossed plastic tape. Factory order only, not stocked (2000 parts per full reel).

   B = Less than full reel. In an effort to simplify our part numbering system, Coilcraft is eliminating the need for multiple packaging codes. When ordering, simply change the last letter of your part number from B to C.

2. Inductance measured at 100 kHz, 0.1 Vrms, 0 Adc.
3. DCR is for each winding.
4. Electrical specifications at 25°C.

Refer to Doc 362 “Soldering Surface Mount Components” before soldering.
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Isolation Transformer HPX2126L

Common Mode Choke HPF2187L

Note 1. C1 = 8 pF minus the output capacitance of the chipset
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Description
Coilcraft’s signal path magnetics meet the current requirements of Gigabit Ethernet PoE Plus. The open circuit inductance is ≥350 µH with a 38 mA dc offset applied from 0°C to 70°C. It can handle 3.8 A of injected current.

The system comprises an isolation transformer, a common mode choke and six capacitors. The capacitor across the primary of the isolation transformer on the TX side tunes the circuit by matching the output capacitance of the chipset allowing these components to be used with virtually all chipsets.

The two isolation transformers are placed in a single package (HPX2126L) and both common mode chokes in an even smaller package (HPF2187L). Both packages fit easily behind a standard Ethernet jack.

Testing
A matching network is used to perform the testing for return loss, insertion loss, crosstalk, common mode to common mode rejection and differential to common mode rejection. The network matches the 50 Ohm single ended connection of network analyzers to 100 Ohm differential balanced lines. A 1:1 balun is used with a resistive network to transform the impedance. The network is then calibrated out of the measurement by using open, short, load calibration techniques. The circuit is then placed behind the matching network for each of the tests. All tests are performed on an Agilent/HP 8753ES network analyzer.

For return loss, the chip side of the component is loaded with 100 Ohms and the cable side of the system is tested using the matching network.

For insertion loss, the fixture used for the return loss is altered to replace the 100 Ohm load with a matching network for the output port of the network analyzer.

For common mode to common mode rejection, TX+ and TX− (or RX+ and RX−), depending on the side of the system) is tied together and an S21 measurement is taken from chip side to cable side.

For differential to common mode rejection, the chip side of the system is excited by the network analyzer through the matching network. The measurement is taken by looking at the balance between two 50 Ohm loads across the cable side of the system.

For crosstalk, the chip side TX is excited by the network analyzer through the matching network. The center-tap on the chip side of each isolation transformer is grounded, and the chip side RX is measured. The cable side of both RX and TX is externally loaded 100 Ohms.

Return Loss

![](chart1.png)

802.3af specification:
18 dB min from 1 MHz to 40 MHz
16 dB min at 50 MHz
12 dB min at 80 MHz
10 dB min at 100 MHz

Insertion Loss

![](chart2.png)

802.3af specification:
1.0 min dB from 0.1 MHz to 100 MHz
1.2 min dB at 125 MHz
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**Common Mode Rejection**

![Common Mode Rejection Graph](image)

**Differential to Common Mode Rejection**

![Differential to Common Mode Rejection Graph](image)

802.3af specification:
- 50 dB min from 1 MHz to 10 MHz
- 30 dB min from 10 MHz to 125 MHz
- 20 dB min from 125 MHz to 500 MHz
- 45 dB min at 30 MHz
- 40 dB min at 60 MHz
- 35 dB min at 100 MHz

**Crosstalk**

![Crosstalk Graph](image)

802.3af specification:
- 45 dB min at 30 MHz
- 40 dB min at 60 MHz
- 33 dB min at 100 MHz

**L vs Offset Current – HPX2126L**

![L vs Offset Current Graph](image)

802.3af specification:
- 50 dB min from 1 MHz to 10 MHz
- 30 dB min from 10 MHz to 125 MHz
- 20 dB min from 125 MHz to 500 MHz
- 45 dB min at 30 MHz
- 40 dB min at 60 MHz
- 35 dB min at 100 MHz

RoHS/REACH compliant